DOCUMENT: R20482 REV LETTER:B PAGE NO: 1 OF 2 DATE: 2014-4-29 PART NUMBER:

Polymer PTC Devices

R-line resettable fuses

CYG Wayon Circuit Protection Co.,Ltd.

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LP75-065F

Features

- □ Radial leaded devices, higher rated voltage of 75V
- □ Cured, flame retardant epoxy polymer insulating material meets UL94 V-0 requirements
- ☐ Agency Recognition: UL、CSA、TUV

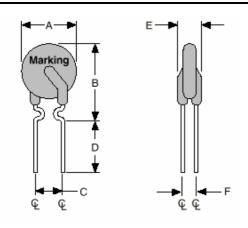




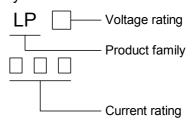


Product Dimensions (mm) Α В С D Ε F Lead Part number Max. Мах. Min. Max. Min. Max. Тур. Size(Φ) LP75-065F 7.6 9.3 13.8 4.4 5.8 3.1 1.1 0.6

E-mail: market@way-on.com



Marking system



^{*} Lead materials: Tin-plate metal wire.

Electrical Characteristics

Part number	I _H	Ι _Τ	T_{trip}		V _{max}	I _{max}	Pd _{typ}	R _{min}	R _{max}	R_{1max}
	(A)	(A)	(A)	(S)	(V)	(A)	(W)	(Ω)	(Ω)	(Ω)
LP75-065F	0.65	1.30	3.25	5.3	75	40	0.90	0.27	0.48	0.72

I_T=Trip current: minimum current at which the device will always trip at 25°C still air.

V_{max}=Maximum voltage device can withstand without damage at rated current.

I_{max}=Maximum fault current device can withstand without damage at rated voltage.

Pd_{typ}=Typical power dissipation: typical amount of power dissipated by the device when in state air environment.

T_{trip}=Maximum time to trip(s) at assigned current

R_{min}=Minimum device resistance at 25℃ prior to trip.

 R_{max} =Maximum device resistance at 25 $^{\circ}$ C prior to trip.

 R_{1max} =Maximum device resistance at 25°C one hour post trip.

Thermal Derating Chart-I_H(A)

Part number	Maximum ambient operating temperatures(℃)										
	-40	-20	0	25	40	50	60	70	85		
LP75-065F	1.10	0.95	0.82	0.65	0.53	0.47	0.40	0.33	0.24		

Package Information

Bulk: 1000pcs per bag.

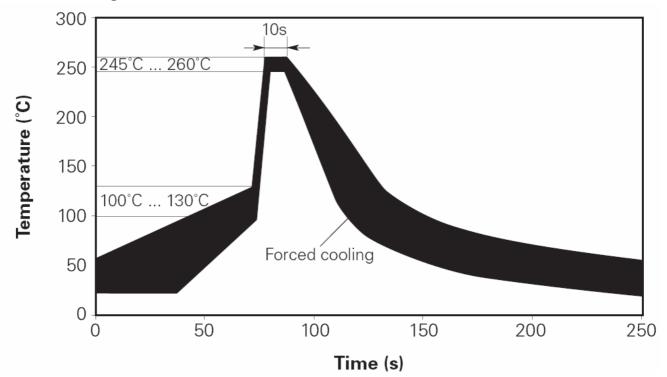
Tape & Reel: 3000pcs per reel.

Specifications are subject to change without notice

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Soldering Recommendations

Wave Soldering



Hand Soldering

Soldering temperature: $350^{\circ}\text{C} \pm 5^{\circ}\text{C}$. Soldering time: no more than 5s.

Soldering position: at least 4 mm away from PTC chip.

单击下面可查看定价,库存,交付和生命周期等信息

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